

## Maximum Ratings (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Unit
Non-Repetitive Peak Reverse Voltage		$V_{RM}$	100	V
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage		Vrrm V <sub>rwm</sub> V <sub>r</sub>	75	V
RMS Reverse Voltage		V <sub>R(RMS)</sub>	53	V
Forward Continuous Current		I <sub>FM</sub>	500	mA
Average Rectified Output Current		lo	250	mA
Non-Repetitive Peak Forward Surge Current	@t = 1.0µs @t = 1.0s	I <sub>FSM</sub>	4 0.5	А

# **Thermal Characteristics**

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 7)	P <sub>D</sub>	200	mW
Thermal Resistance Junction to Ambient Air (Note 7)	$R_{\theta JA}$	625	°C/W
Operating and Storage Temperature Range	T <sub>J</sub> , T <sub>STG</sub>	-65 to +150	°C

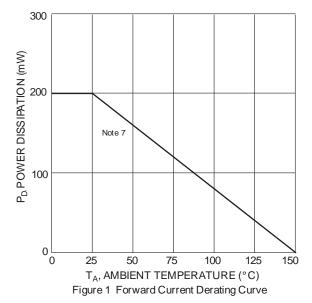
# Electrical Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

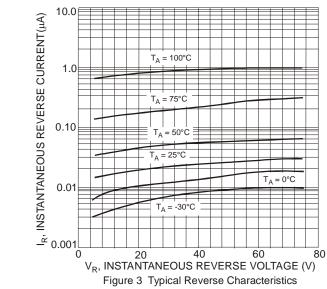
Characteristic	Symbol	Min	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 6)	V <sub>(BR)R</sub>	75		V	$I_R = 2.5\mu A$
Forward Voltage	$V_{FM}$	0.62 — — —	0.72 0.855 1.0 1.25	٧	I <sub>F</sub> = 5.0mA I <sub>F</sub> = 10mA I <sub>F</sub> = 100mA I <sub>F</sub> = 150mA
Peak Reverse Current (Note 6)	I <sub>RM</sub>	_	2.5 50 30 25	μΑ μΑ μΑ nA	$V_R = 75V$ $V_R = 75V$ , $T_J = +150$ °C $V_R = 25V$ , $T_J = +150$ °C $V_R = 20V$
Total Capacitance	Ст	_	4.0	pF	V <sub>R</sub> = 0, f = 1.0MHz
Reverse Recovery Time	t <sub>RR</sub>	_	4.0	ns	$I_F = I_R = 10 \text{mA},$ $I_{RR} = 0.1 \text{ x } I_R, R_L = 100 \Omega$

Notes:

<sup>6.</sup> Short duration pulse test used to minimize self-heating.7. Part mounted on FR-4 PC board with minimum recommended pad layouts, which can be found on our website http://www.diodes.com/datasheets/ap02001.pdf.







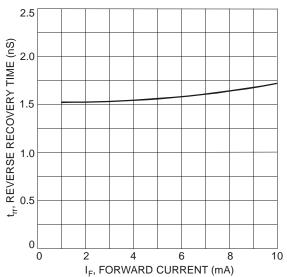
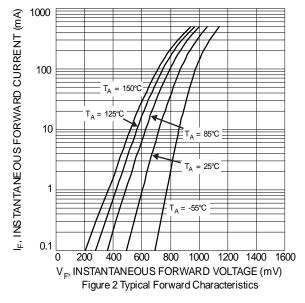
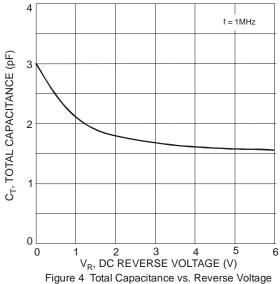


Figure 5 Reverse Recovery Time vs. Forward Current

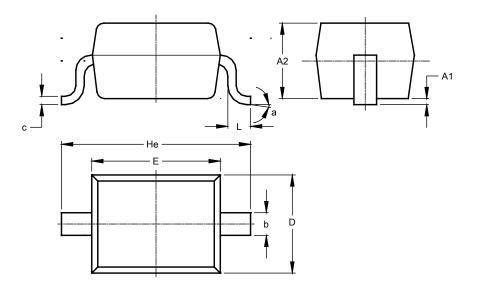






## **Package Outline Dimensions**

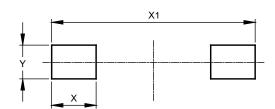
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for the latest version.



SOD323				
Dim	Min	Max	Тур	
A1		0.10	0.05	
A2	1.00	1.10	1.05	
b	0.25	0.35	0.30	
С	0.10	0.15	0.11	
D	1.20	1.40	1.30	
Е	1.60	1.80	1.70	
He	2.30	2.70	2.50	
L	0.20	0.40	0.30	
а	0°	8°		
All Dimensions in mm				

# **Suggested Pad Layout**

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



Dimensions	Value (in mm)
Х	0.590
X1	2.700
Y	0.450



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